



UT3419A

Power MOSFET

20V, 3.5A P-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

DESCRIPTION

The UTC **UT3419A** is a P-channel enhancement MOSFET providing designers with excellent $R_{DS(ON)}$, low gate charge. The gate voltage is as low as 2.5V.

The UTC **UT3419A** can be applied in PWM applications or used as a load switch.

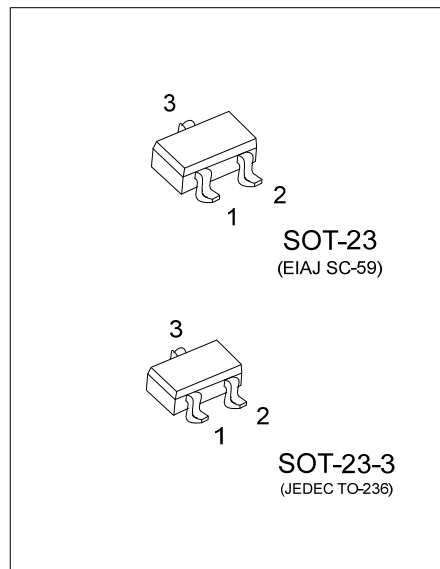
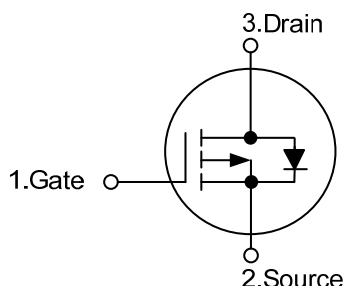
FEATURES

* $R_{DS(ON)} \leq 75 \text{ m}\Omega$ @ $V_{GS} = -10\text{V}$, $I_D = -3.5\text{A}$

* $R_{DS(ON)} \leq 95 \text{ m}\Omega$ @ $V_{GS} = -4.5\text{V}$, $I_D = -3.0\text{A}$

* $R_{DS(ON)} \leq 155 \text{ m}\Omega$ @ $V_{GS} = -2.5\text{V}$, $I_D = -1.0\text{A}$

SYMBOL



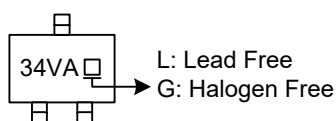
ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UT3419AL-AE2-R	UT3419AG-AE2-R	SOT-23-3	G	S	D	Tape Reel
UT3419AL-AE3-R	UT3419AG-AE3-R	SOT-23	G	S	D	Tape Reel

Note: Pin Assignment: G: Gate S: Source D: Drain

UT3419AG-AE2-R	(1) Packing Type (2) Package Type (3) Green Package	(1) R: Tape Reel (2) AE2: SOT-23-3, AE3: SOT-23 (3) G: Halogen Free and Lead Free, L: Lead Free
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MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain to Source Voltage	V_{DS}	-20	V
Gate to Source Voltage	V_{GS}	± 12	V
Continuous Drain Current (Note 1)	$T_A = 25^\circ\text{C}$	I_D	-3.5
	$T_A = 70^\circ\text{C}$		-2.8
Pulsed Drain Current (Note 2)	I_{DM}	-15	A
Total Power Dissipation (Note 1)	$T_A = 25^\circ\text{C}$	P_D	0.6
	$T_A = 70^\circ\text{C}$		0.4
Junction Temperature	T_J	-55 ~ +150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient (Note 1)	$t \leq 10\text{s}$	θ_{JA}	208
	Steady-State		290

Notes: 1. The value of θ_{JA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$. The value in any a given application depends on the user's specific board design. The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.

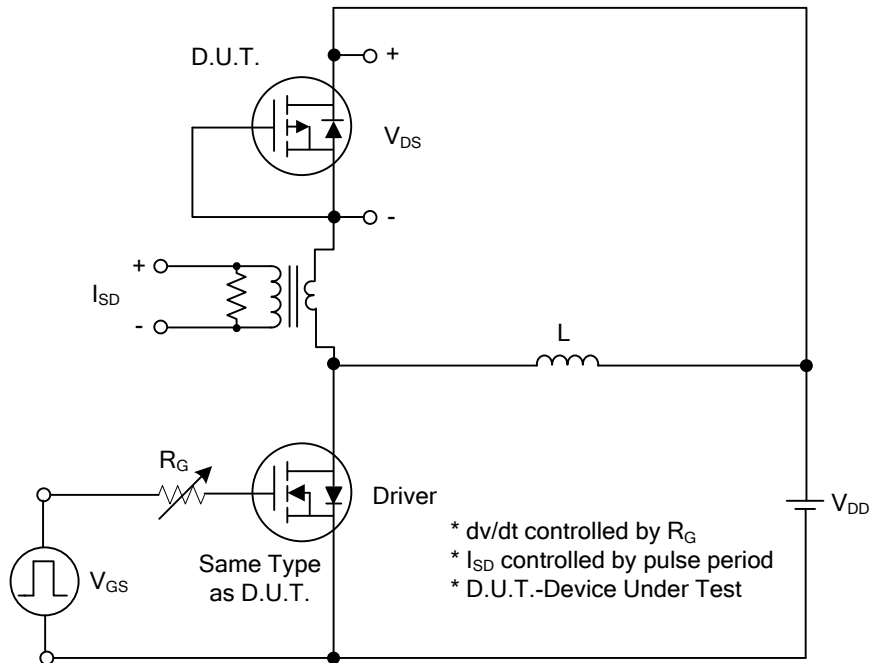
■ ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250μA	-20			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =-16V, V _{GS} =0V			-0.5	μA
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±10V			±100	nA
		V _{DS} =0V, V _{GS} =±12V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} = V _{GS} , I _D =-250μA	-0.5		-1.2	V
On State Drain Current	I _{D(ON)}	V _{GS} =-4.5V, V _{DS} =-5V	-15			A
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-3.5A		59	75	mΩ
		V _{GS} =-4.5V, I _D =-3.0A		75	95	mΩ
		V _{GS} =-2.5V, I _D =-1.0A		135	155	mΩ
DYNAMIC PARAMETERS						
Input Capacitance	C _{ISS}	V _{DS} =-10V, V _{GS} =0V, f =1MHz		434	620	pF
Output Capacitance	C _{OSS}			100		pF
Reverse Transfer Capacitance	C _{RSS}			82		pF
Gate Resistance	R _G	V _{GS} =0V, V _{DS} =0V, f =1MHz			13	Ω
SWITCHING PARAMETERS						
Total Gate Charge	Q _G	V _{DS} =-10V, V _{GS} =-4.5V, I _D =-3.5A		7.0	9.0	nC
Gate-Source Charge	Q _{GS}			1.5		nC
Gate-Drain Charge	Q _{GD}			2.2		nC
Turn-ON Delay Time	t _{D(ON)}	V _{DS} =-10V, V _{GS} =-10V, I _D = -3.5A, R _{GEN} =3Ω		3		ns
Turn-ON Rise Time	t _R			16		ns
Turn-OFF Delay Time	t _{D(OFF)}			18		ns
Turn-OFF Fall Time	t _F			20		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I _S				-2	A
Drain-Source Diode Forward Voltage	V _{SD}	I _S =-1.0A, V _{GS} =0V			-1.2	V

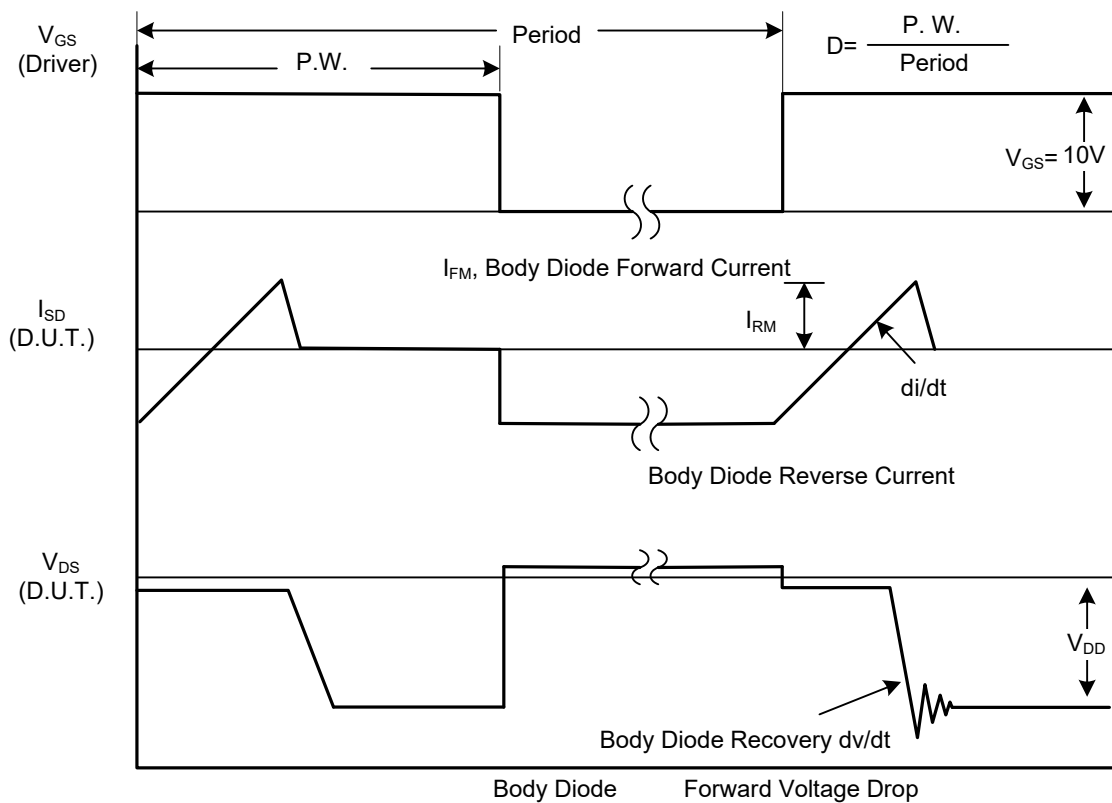
Notes: 1. The θ_{JA} is the sum of the thermal impedance from junction to lead θ_{JL} and lead to ambient.

2. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The SOA curve provides a single pulse rating.

■ TEST CIRCUITS AND WAVEFORMS

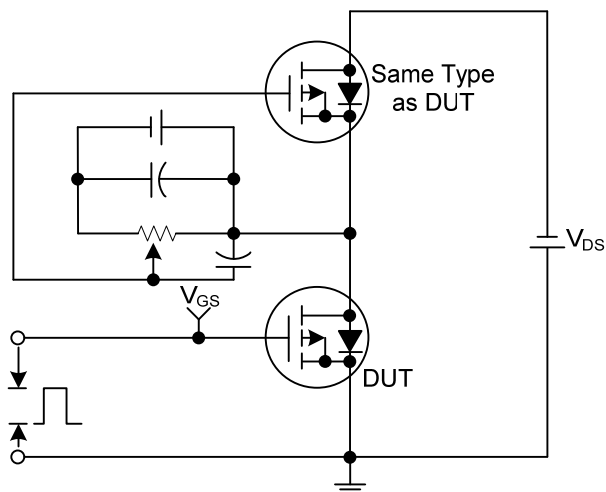


Peak Diode Recovery dv/dt Test Circuit

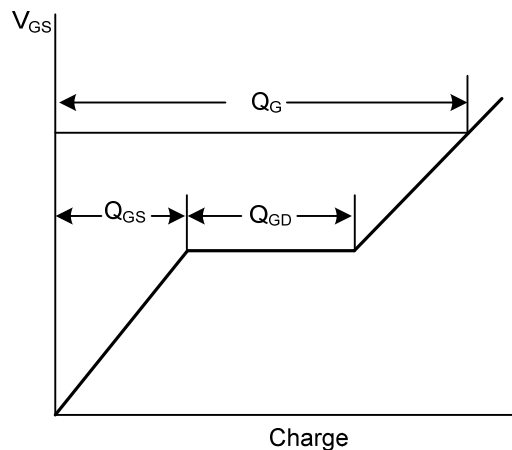


Peak Diode Recovery dv/dt Waveforms

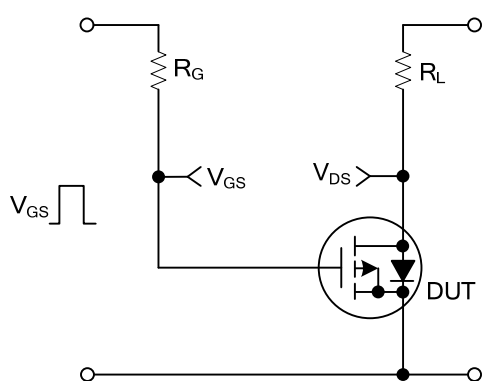
■ TEST CIRCUITS AND WAVEFORMS



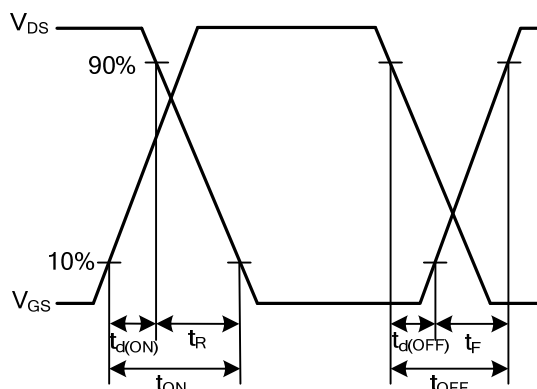
Gate Charge Test Circuit



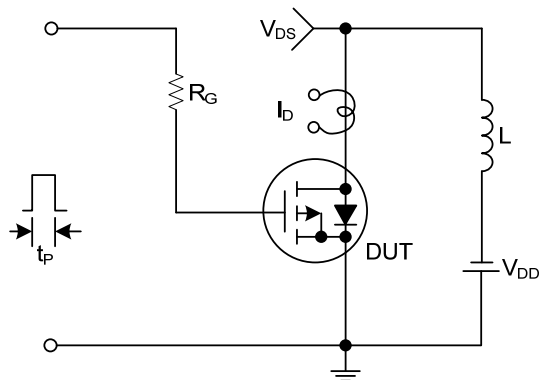
Gate Charge Waveforms



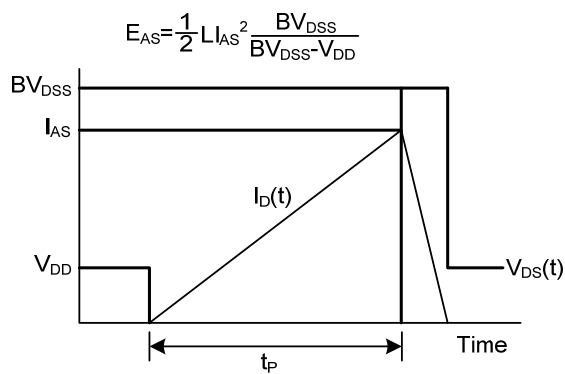
Resistive Switching Test Circuit



Resistive Switching Waveforms

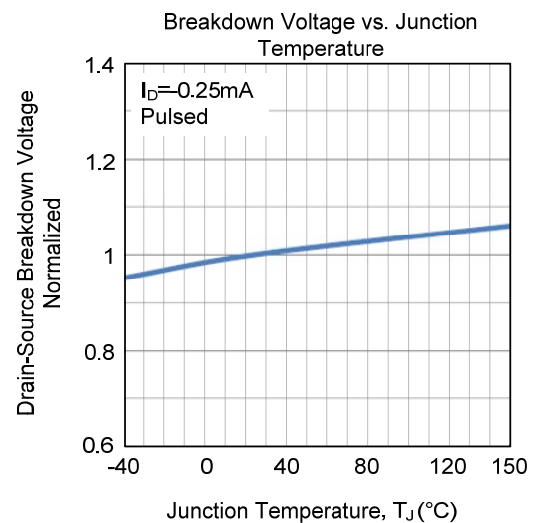
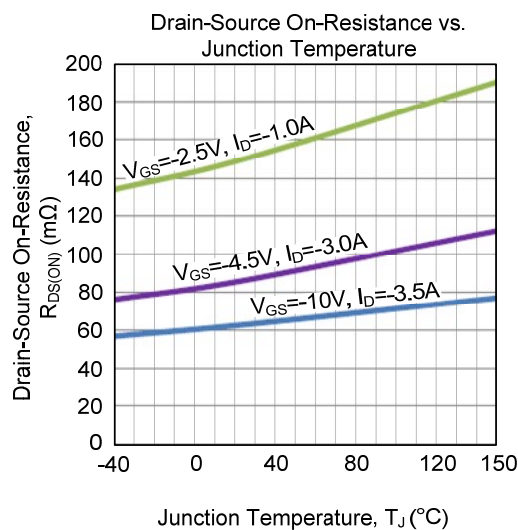
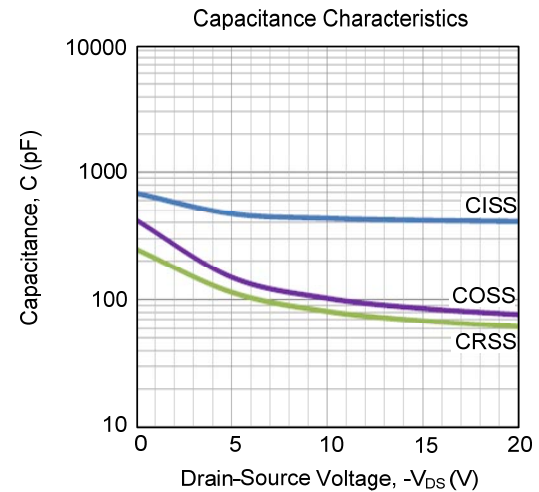
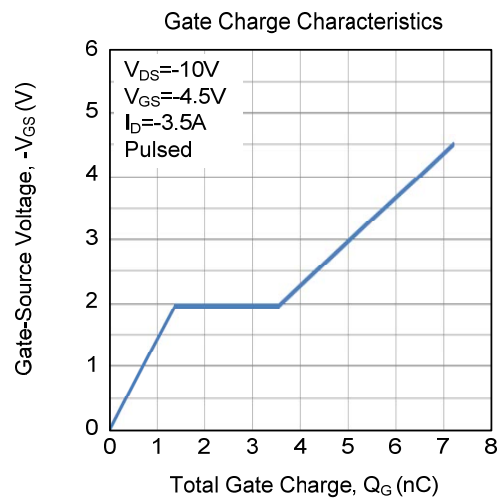
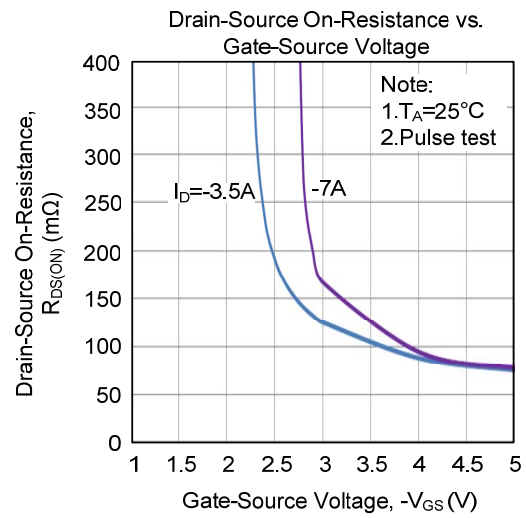
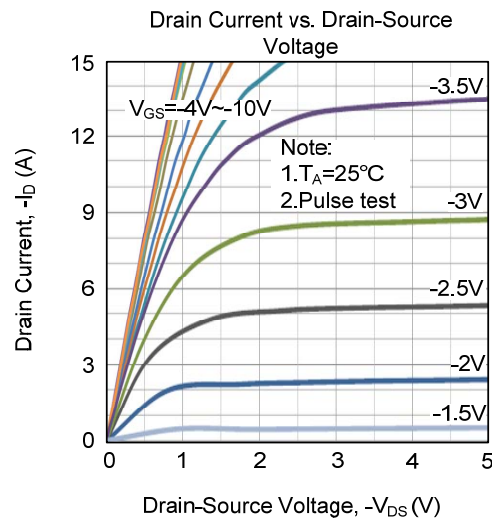


Unclamped Inductive Switching Test Circuit

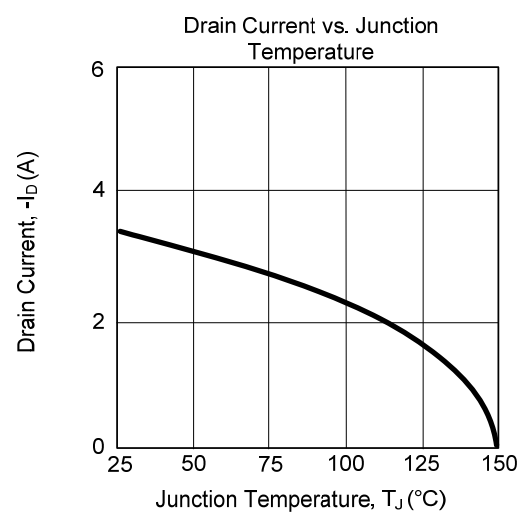
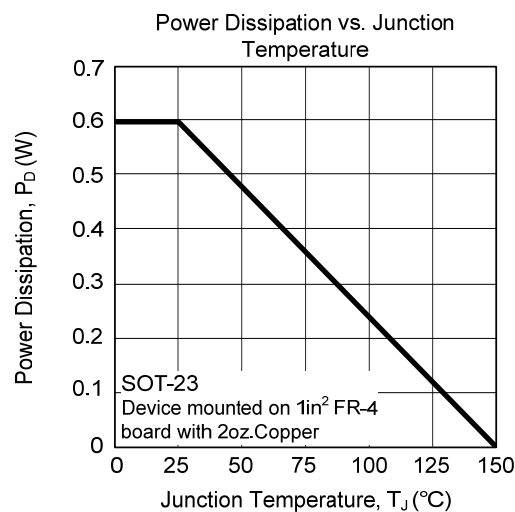
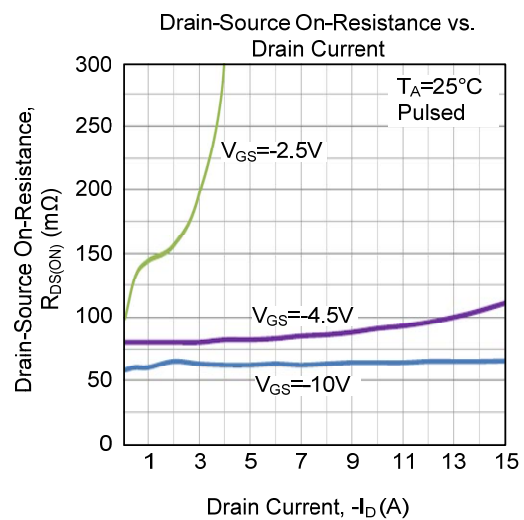
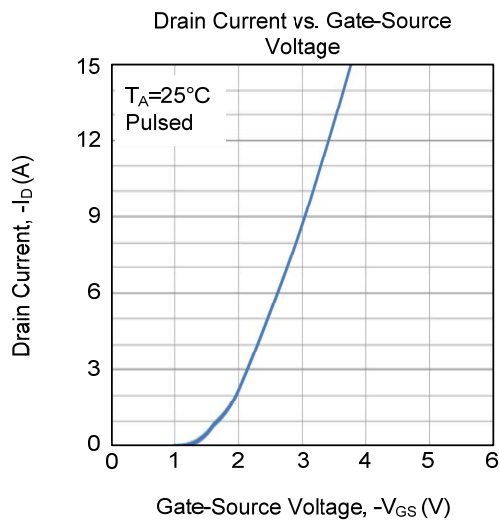
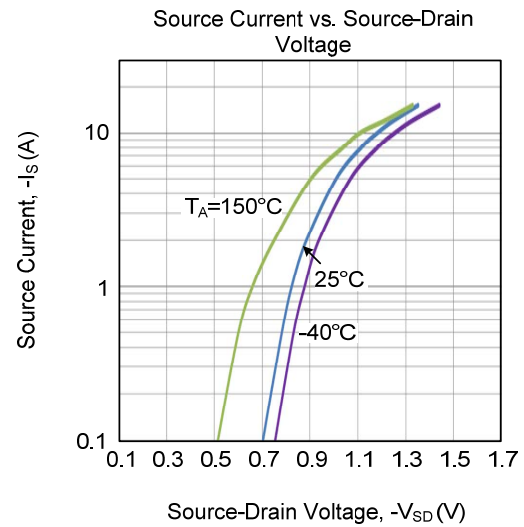
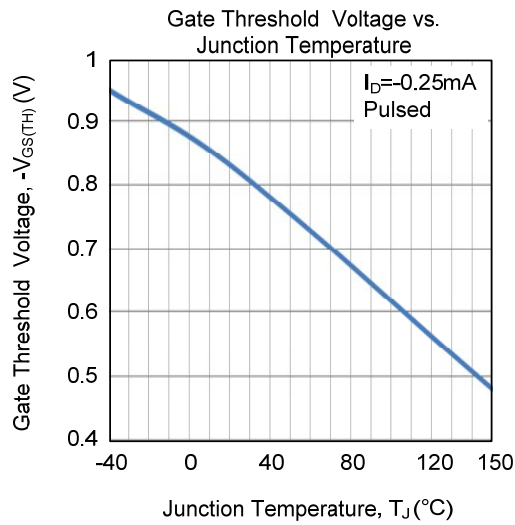


Unclamped Inductive Switching Waveforms

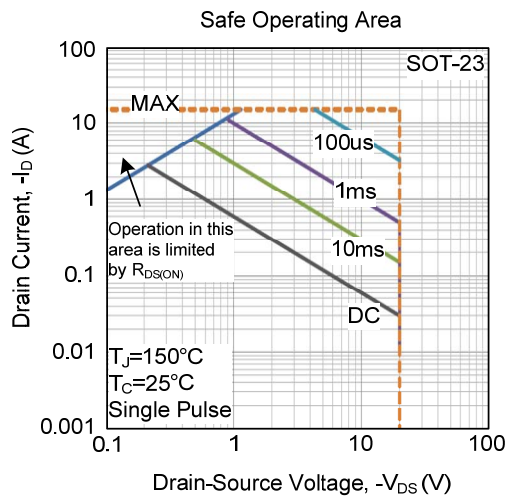
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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